DT04 Rec'd PCT/PTO 0 8 OCT 2004

## **Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

Cancel claims 1 - 23 and replace with claims 24 - 53.

Claims 1 - 23. Cancelled.

A process for preparing halogen-containing silanes of the general 24. (New) formula (I):

$$R_a H_b SiX_c$$
 (I)

where

- is a substituted or unsubstituted  $C_{1-10}$  alkyl or  $C_{6-10}$  aryl radical of which one or more R carbon atoms are optionally replaced by -CO-, -CO $_2$ -, -O-, -S-, -SO-, -SO $_2$ -, -NH- or -NR'-, where R' is a substituted or unsubstituted alkyl radical having from 1 to 20 carbon atoms,
- X is fluorine, chlorine or bromine,
- is an integer of 0, 1, 2 or 3, a
- is an integer of 0, 1, 2 or 3 and b
- is an integer of 1, 2, 3 or 4,

with the proviso that the sum of a + b + c = 4,

comprising reacting silicon, under the action of microwave energy, with elements or compounds selected from the group consisting of halogens; halogens and organohalogen compounds; halogens and hydrogen; halogens and hydrogen halides; organohalogen compounds; organohalogen compounds and hydrogen; organohalogen compounds and hydrogen halide; hydrogen halides; fluorosilanes and hydrogen; fluorosilanes and hydrogen halide; hydrogen-containing chlorosilanes and hydrogen; hydrogen-containing

chlorosilanes and hydrogen halides; organohalosilanes and hydrogen; organohalosilanes and hydrogen halides; and hydrocarbons and hydrogen halides.

- 25. (New) The process of claim 24, wherein silicon is contacted with halogen, a halogen compound, or mixture thereof in gaseous form and exposed to microwave energy.
  - 26. (New) The process of claim 24, wherein crystalline silicon is used.
- 27. (New) The process of claim 24, wherein coarsely crystalline silicon is used.
  - 28. (New) The process of claim 24, wherein amorphous silicon is used.
- 29. (New) The process of claim 28, wherein amorphous silicon is used in admixture with crystalline silicon.
- 30. (New) The process of claim 24, further comprising employing a catalyst or promoter.
- 31. (New) The process of claim 24, further comprising employing a substance which absorbs microwave energy and transfers thermal energy to silicon.
- 32. (New) The process of claim 24, wherein said compound comprises a hydrogen halide.
- 33. (New) The process of claim 24, further comprising employing a metal or metal compound as a catalyst or promoter.
  - 34. (New) The process of claim 33, wherein said promoter comprises Cu.

Atty Dkt No. WAS0662PUSA

S/N: PCT/DE03/01270

- 35. (New) The process of claim 24, wherein nonpulsed microwave energy is used.
- 36. (New) The process of claim 24, wherein said silicon has a mean particle size of  $> 70 \ \mu m$ .
- 37. (New) The process of claim 24, wherein said organohalogen compound comprises an alkyl halide or aryl halide.
- 38. (New) The process of claim 24, wherein said organohalogen compound comprises methyl chloride.
- 39. (New) The process of claim 24, wherein silicon is employed in the form of a silicon alloy.
- 40. (New) The process of claim 39, wherein said silicon alloy is ferrosilicon.
- 41. (New) The process of claim 24, wherein said halogen-containing silane comprises compounds of the formula  $F_nSiH_{4-n}$  where n=1-3, prepared by contacting elemental silicon and fluorosilanes under microwave excitation with hydrogen, hydrogen fluoride, or hydrogen and hydrogen fluoride.
- 42. (New) The process of claim 41, wherein elemental silicon and  $SiF_4$  gas are contacted under microwave excitation with hydrogen, hydrogen fluoride, or hydrogen and hydrogen fluoride.
- 43. (New) The process of claim 24, wherein said halogen-containing silane comprises compounds of the formula  $Cl_nSiH_{4-n}$  where n=1-3, prepared by contacting elemental silicon and one or more hydrogen-containing chlorosilanes under microwave excitation with hydrogen, hydrogen chloride, or hydrogen and hydrogen chloride.

- 44. (New) The process of claim 41, wherein a mixture of different compounds  $F_nSiH_{4-n}$  is prepared.
- 45. (New) The process of claim 43, wherein a mixture of different compounds of  $Cl_nSiH_{4-n}$  is prepared.
- 46. (New) The process of claim 44, wherein the mixture is separated by low-temperature condensation or by liquid distillation.
- 47. (New) The process of claim 45, wherein the mixture is separated by low-temperature condensation or by liquid distillation.
- 48. (New) The process of claim 41, wherein the hydrogen content of the products is regulated by varying the concentration of hydrogen and/or hydrogen halide.
- 49. (New) The process of claim 43, wherein the hydrogen content of the products is regulated by varying the concentration of hydrogen and/or hydrogen halide.
- 50. (New) The process of claim 24, wherein compounds of the formula  $X_nSiH_{4-n}$  are obtained, where X is F or Cl and n is 1-3, further comprising pyrolytically decomposing the  $X_nSiH_{4-n}$  compounds to obtain highly pure silicon.
- 51. (New) The process of claim 50, wherein gases formed during pyrolytic decomposition are recycled or used directly to synthesize  $SiX_4$  where X is fluorine or chlorine.
- 52. (New) The process of claim 24, wherein elemental silicon and one or more organohalogen compounds are contacted under microwave excitation with hydrogen, hydrogen halide, or hydrogen and hydrogen halide.
- 53. (New) The process of claim 24, wherein the hydrocarbon is methane or ethane.